



# THE DATASHEET OF TLP621X





## TLP621, TLP621-2, TLP621-4



### DESCRIPTION

The TLP621, TLP621-2 and TLP621-4 series of optically coupled isolator consist of an infrared light emitting diode and an NPN silicon photo transistor in a space efficient Dual In Line Plastic Package.

### FEATURES

- AC Isolation Voltage 5300V<sub>RMS</sub>
- CTR Selections Available
- Wide Operating Temperature Range -30°C to +100°C
- Lead Free and RoHS Compliant
- UL File E91231 Package Code "EE"
- VDE Approval Certificate No. 40028086

### APPLICATIONS

- Computer Terminals
- Industrial System Controllers
- Measuring Instruments
- Signal Transmission between Systems of Different Potentials and Impedances

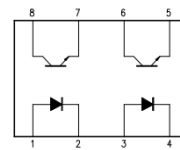
### ORDER INFORMATION

- Add X after PN for VDE Approval
- Add G after PN for 10mm lead spacing
- Add SM after PN for Surface Mount
- Add SMT&R after PN for Surface Mount Tape & Reel  
(Available for TLP621SM and TLP621-2SM)

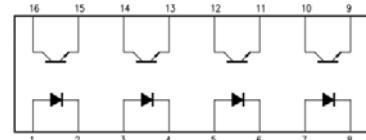
**TLP621**



**TLP621-2**



**TLP621-4**



### ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C)

Stresses exceeding the absolute maximum ratings can cause permanent damage to the device.

Exposure to absolute maximum ratings for long periods of time can adversely affect reliability.

#### Input

|                   |      |
|-------------------|------|
| Forward Current   | 50mA |
| Reverse Voltage   | 6V   |
| Power dissipation | 70mW |

#### Output

|  |       |
|--|-------|
| Collector to Emitter Voltage BV <sub>CEO</sub> | 55V   |
| Emitter to Collector Voltage BV <sub>ECO</sub> | 6V    |
| Collector Current                              | 50mA  |
| Power Dissipation                              | 150mW |

#### Total Package

|                                  |                      |
|----------------------------------|----------------------|
| Isolation Voltage                | 5300V <sub>RMS</sub> |
| Total Power Dissipation          | 200mW                |
| Operating Temperature            | -30 to 100 °C        |
| Storage Temperature              | -55 to 125 °C        |
| Lead Soldering Temperature (10s) | 260°C                |

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## TLP621, TLP621-2, TLP621-4

### ELECTRICAL CHARACTERISTICS (Ambient Temperature = 25°C unless otherwise specified)

#### INPUT

| Parameter            | Symbol | Test Condition                   | Min | Typ. | Max | Unit          |
|----------------------|--------|----------------------------------|-----|------|-----|---------------|
| Forward Voltage      | $V_F$  | $I_F = 10\text{mA}$              | 1.0 | 1.15 | 1.3 | V             |
| Reverse Voltage      | $V_R$  | $I_R = 10\mu\text{A}$            | 5.0 |      |     | V             |
| Reverse Leakage      | $I_R$  | $V_R = 5\text{V}$                |     |      | 10  | $\mu\text{A}$ |
| Terminal Capacitance | $C_t$  | $V = 0\text{V}, f = 1\text{KHz}$ |     | 30   | 250 | pF            |

#### OUTPUT

| Parameter                           | Symbol     | Test Condition                           | Min | Typ. | Max | Unit |
|-------------------------------------|------------|--|-----|------|-----|------|
| Collector—Emitter breakdown Voltage | $BV_{CEO}$ | $I_C = 0.5\text{mA}, I_F = 0\text{mA}$   | 55  |      |     | V    |
| Emitter—Collector breakdown Voltage | $BV_{ECO}$ | $I_E = 100\mu\text{A}, I_F = 0\text{mA}$ | 6   |      |     | V    |
| Collector-Emitter Dark Current      | $I_{CEO}$  | $V_{CE} = 24\text{V}, I_F = 0\text{mA}$  |     |      | 100 | nA   |



**TLP621, TLP621-2, TLP621-4**

**ELECTRICAL CHARACTERISTICS (Ambient Temperature = 25°C unless otherwise specified)**

**COUPLED**

| Parameter                            | Symbol               | Test Condition  | Min | Typ. | Max        | Unit          |
|--------------------------------------|----------------------|---|-----|------|------------|---------------|
| Current Transfer Ratio               | CTR                  | $I_F = 5\text{mA}$ , $V_{CE} = 5\text{V}$   | 50  |      | 600        | %             |
|                                      |                      | Optional CTR Grades   |     |      |            |               |
|                                      |                      | GR  | 100 |      | 300        |               |
|                                      |                      | BL  | 200 |      | 600        |               |
|                                      |                      | GB  | 100 |      | 600        |               |
|                                      |                      | GB ( $I_F = 1\text{mA}$ , $V_{CE} = 0.4\text{V}$ )  | 30  |      |            |               |
| Collector—Emitter Saturation Voltage | $V_{CE(\text{sat})}$ | $I_F = 8\text{mA}$ , $I_C = 2.4\text{mA}$<br>GB ( $I_F = 1\text{mA}$ , $I_C = 0.2\text{mA}$ ) |     |      | 0.4<br>0.4 | V             |
| Output Rise Time                     | $t_r$                | $V_{CE} = 10\text{V}$ ,<br>$I_C = 2\text{mA}$ ,<br>$R_L = 100\Omega$                          |     | 2    |            | $\mu\text{s}$ |
| Output Fall Time                     | $t_f$                |   |     | 3    |            |               |
| Turn-on Time                         | $t_{\text{on}}$      |   |     | 3    |            |               |
| Turn-off Time                        | $t_{\text{off}}$     |   |     | 3    |            |               |

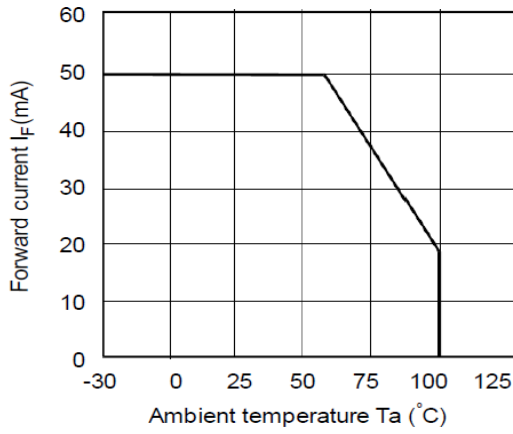
**ISOLATION**

| Parameter                            | Symbol           | Test Condition                          | Min                | Typ. | Max | Unit             |
|--------------------------------------|------------------|---|--------------------|------|-----|------------------|
| Input to Output Isolation Voltage    | $V_{\text{ISO}}$ | AC 1 minute, RH = 40 to 60%<br>Note 1   | 5300               |      |     | $V_{\text{RMS}}$ |
| Input to Output Isolation Resistance | $R_{\text{ISO}}$ | $V_{\text{IO}} = 500\text{V}$<br>Note 1 | $5 \times 10^{10}$ |      |     | $\Omega$         |

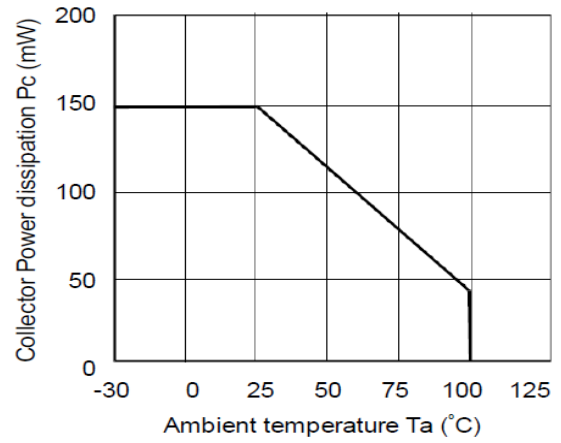
Note 1 : Measure with input leads shorted together and output leads shorted together.



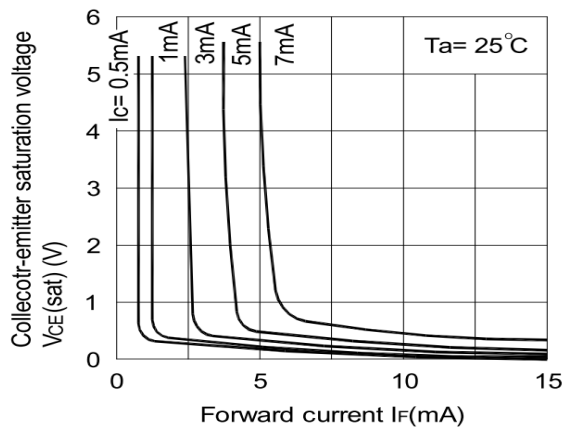
## TLP621, TLP621-2, TLP621-4



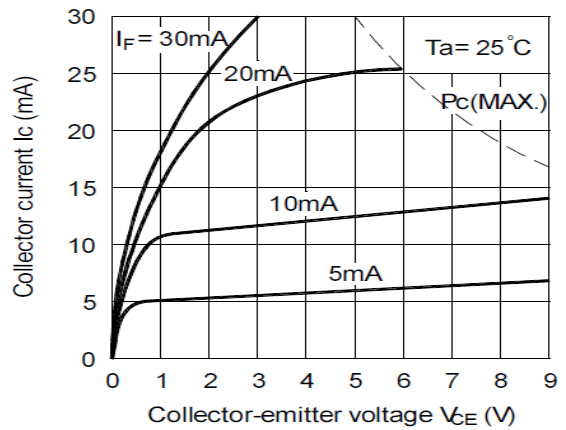
**Fig 1 Forward Current vs  $T_A$**



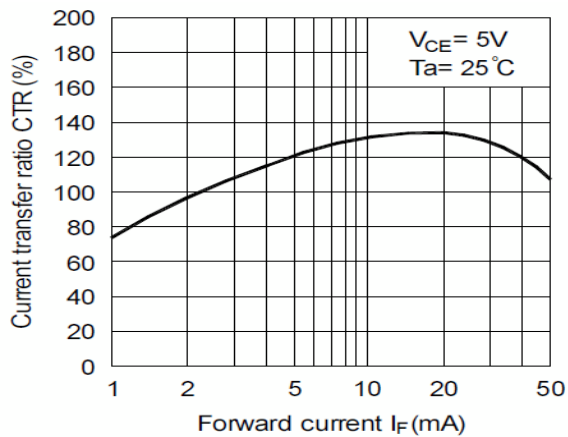
**Fig 2 Collector Power Dissipation vs  $T_A$**



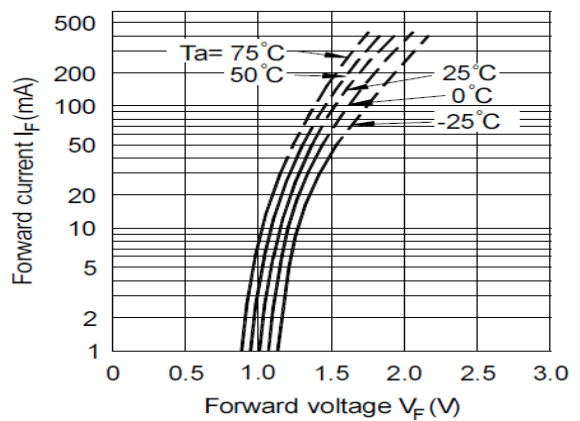
**Fig 3 Collector-emitter Saturation Voltage vs Forward Current**



**Fig 4 Collector Current vs Collector-emitter Voltage**



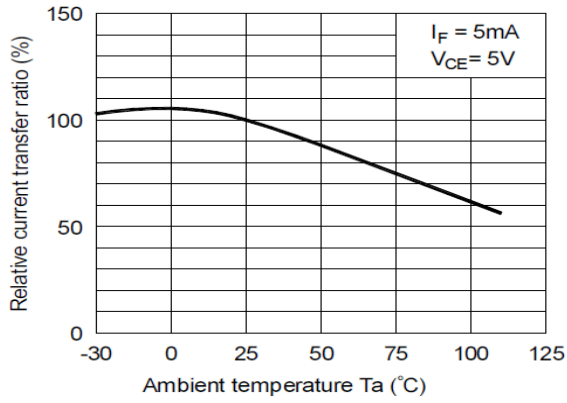
**Fig 5 Current Transfer Ratio vs Forward Current**



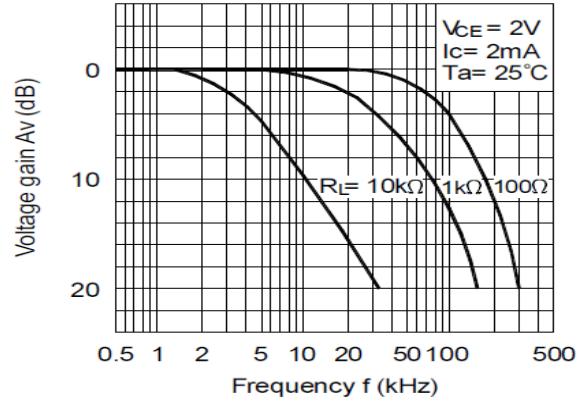
**Fig 6 Forward Current vs Forward Voltage**



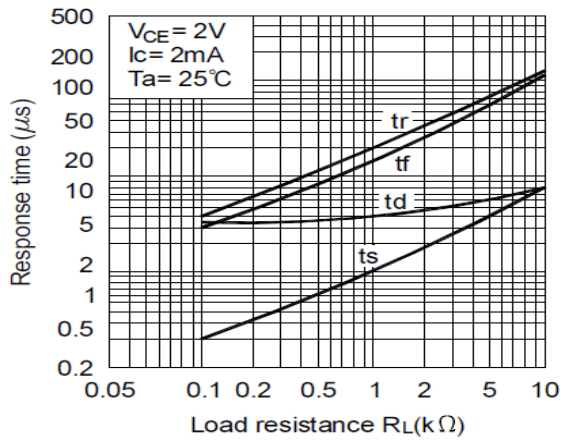
## TLP621, TLP621-2, TLP621-4



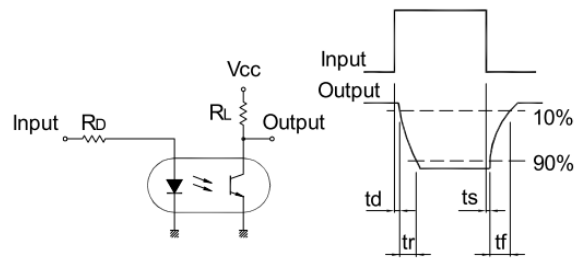
**Fig 7 Relative CTR vs  $T_A$**



**Fig 8 Frequency Response**



**Fig 9 Response Time vs Load Resistance**



**Response Time Test Circuit**



## TLP621, TLP621-2, TLP621-4

### ORDER INFORMATION

| TLP621 (UL Approval) |   |                           |                   |
|----------------------|---|---------------------------|-------------------|
| After PN             | PN  | Description               | Packing quantity  |
| None                 | TLP621, TLP621GR,<br>TLP621BL, TLP621GB                           | Standard DIP4             | 100 pcs per tube  |
| G                    | TLP621G, TLP621GRG,<br>TLP621BLG, TLP621GBG                       | 10mm Lead Spacing         | 100 pcs per tube  |
| SM                   | TLP621SM, TLP621GRSM,<br>TLP621BLSM, TLP621GBSM                   | Surface Mount             | 100 pcs per tube  |
| SMT&R                | TLP621SMT&R,<br>TLP621GRSMT&R,<br>TLP621BLSMT&R,<br>TLP621GBSMT&R | Surface Mount Tape & Reel | 1000 pcs per reel |

| TLP621-2 (UL Approval) |   |                           |                   |
|------------------------|---|---------------------------|-------------------|
| After PN               | PN  | Description               | Packing quantity  |
| None                   | TLP621-2, TLP621-2GR,<br>TLP621-2BL, TLP621-2GB                           | Standard DIP8             | 50 pcs per tube   |
| G                      | TLP621-2G, TLP621-2GRG,<br>TLP621-2BLG, TLP621-2GBG                       | 10mm Lead Spacing         | 50 pcs per tube   |
| SM                     | TLP621-2SM, TLP621-2GRSM,<br>TLP621-2BLSM,<br>TLP621-2GBSM                | Surface Mount             | 50 pcs per tube   |
| SMT&R                  | TLP621-2SMT&R,<br>TLP621-2GRSMT&R,<br>TLP621-2BLSMT&R,<br>TLP621-2GBSMT&R | Surface Mount Tape & Reel | 1000 pcs per reel |

| TLP621-4 (UL Approval) |   |                   |                  |
|------------------------|---|-------------------|------------------|
| After PN               | PN  | Description       | Packing quantity |
| None                   | TLP621-4, TLP621-4GR,<br>TLP621-4BL, TLP621-4GB               | Standard DIP16    | 25 pcs per tube  |
| G                      | TLP621-4G, TLP621-4GRG,<br>TLP621-4BLG, TLP621-4GBG           | 10mm Lead Spacing | 25 pcs per tube  |
| SM                     | TLP621-4SM,<br>TLP621-4GRSM,<br>TLP621-4BLSM,<br>TLP621-4GBSM | Surface Mount     | 25 pcs per tube  |



**TLP621, TLP621-2, TLP621-4**

**ORDER INFORMATION**

| <b>TLP621X (UL and VDE Approvals)</b> |  |                           |                         |
|---------------------------------------|--|---------------------------|-------------------------|
| <b>After PN</b>                       | <b>PN</b>  | <b>Description</b>        | <b>Packing quantity</b> |
| None                                  | TLP621X, TLP621XGR,<br>TLP621XBL, TLP621XGB                            | Standard DIP4             | 100 pcs per tube        |
| G                                     | TLP621XG, TLP621XGRG,<br>TLP621XBLG, TLP621XGBG                        | 10mm Lead Spacing         | 100 pcs per tube        |
| SM                                    | TLP621XSM, TLP621XGRSM,<br>TLP621XBLSM, TLP621XGBSM                    | Surface Mount             | 100 pcs per tube        |
| SMT&R                                 | TLP621XSMT&R,<br>TLP621XGRSMT&R,<br>TLP621XBLSMT&R,<br>TLP621XGBXSMT&R | Surface Mount Tape & Reel | 1000 pcs per reel       |

| <b>TLP621-2X (UL and VDE Approvals)</b> |   |                           |                         |
|---|---|---------------------------|-------------------------|
| <b>After PN</b>                         | <b>PN</b>   | <b>Description</b>        | <b>Packing quantity</b> |
| None                                    | TLP621-2X, TLP621-2XGR,<br>TLP621-2XBL, TLP621-2XGB                           | Standard DIP8             | 50 pcs per tube         |
| G                                       | TLP621-2XG, TLP621-2XGRG,<br>TLP621-2XBLG, TLP621-2XGBG                       | 10mm Lead Spacing         | 50 pcs per tube         |
| SM                                      | TLP621-2XSM,<br>TLP621-2XGRSM,<br>TLP621-2XBLSM,<br>TLP621-2XGBSM             | Surface Mount             | 50 pcs per tube         |
| SMT&R                                   | TLP621-2XSMT&R,<br>TLP621-2XGRSMT&R,<br>TLP621-2XBLSMT&R,<br>TLP621-2XGBSMT&R | Surface Mount Tape & Reel | 1000 pcs per reel       |

| <b>TLP621-4X (UL and VDE Approvals)</b> |   |                    |                         |
|---|---|--------------------|-------------------------|
| <b>After PN</b>                         | <b>PN</b>   | <b>Description</b> | <b>Packing quantity</b> |
| None                                    | TLP621-4X, TLP621-4XGR,<br>TLP621-4XBL, TLP621-4XGB               | Standard DIP16     | 25 pcs per tube         |
| G                                       | TLP621-4XG, TLP621-4XGRG,<br>TLP621-4XBLG, TLP621-4XGBG           | 10mm Lead Spacing  | 25 pcs per tube         |
| SM                                      | TLP621-4XSM,<br>TLP621-4XGRSM,<br>TLP621-4XBLSM,<br>TLP621-4XGBSM | Surface Mount      | 25 pcs per tube         |

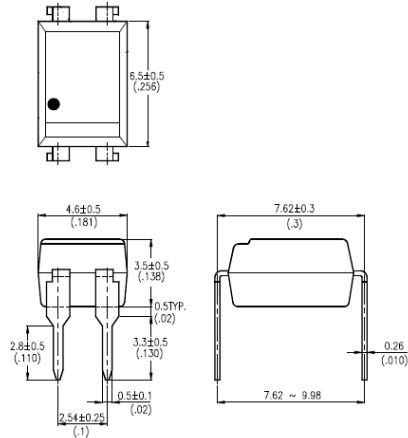


## TLP621, TLP621-2, TLP621-4

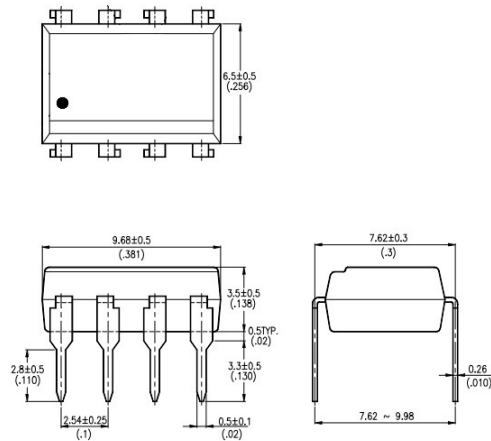
### PACKAGE DIMENSIONS in mm (inch)

#### DIP

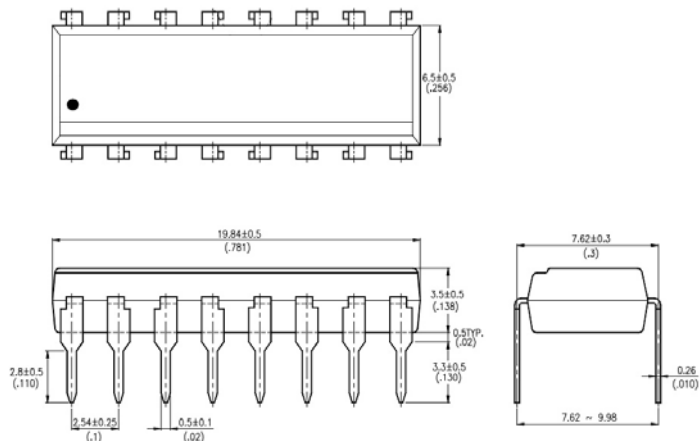
**TLP621**



**TLP621-2**



**TLP621-4**



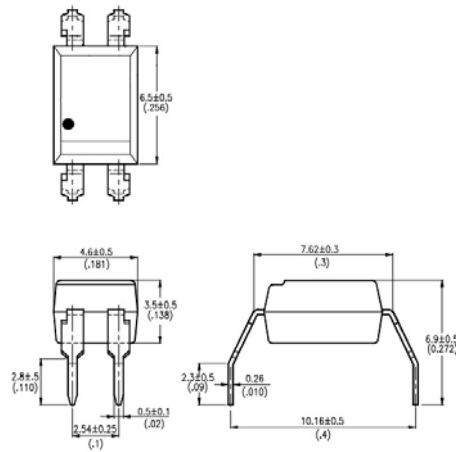


## TLP621, TLP621-2, TLP621-4

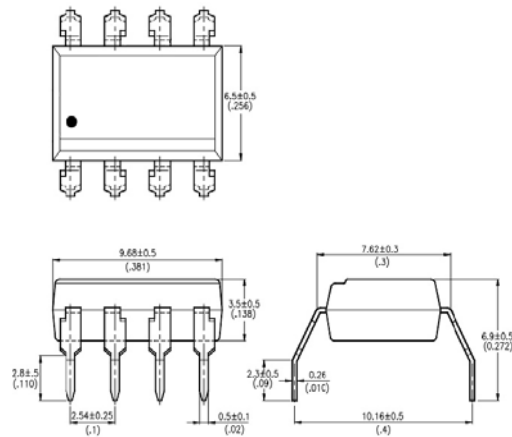
### PACKAGE DIMENSIONS in mm (inch)

#### G Form

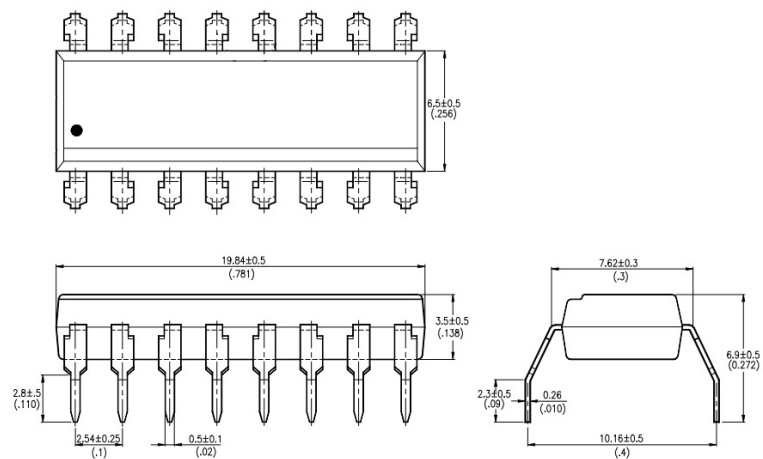
**TLP621G**



**TLP621-2G**



**TLP621-4G**



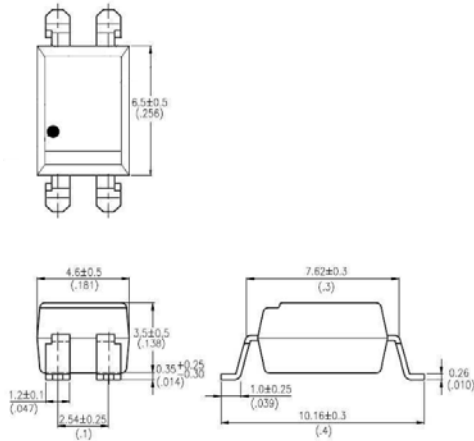


## TLP621, TLP621-2, TLP621-4

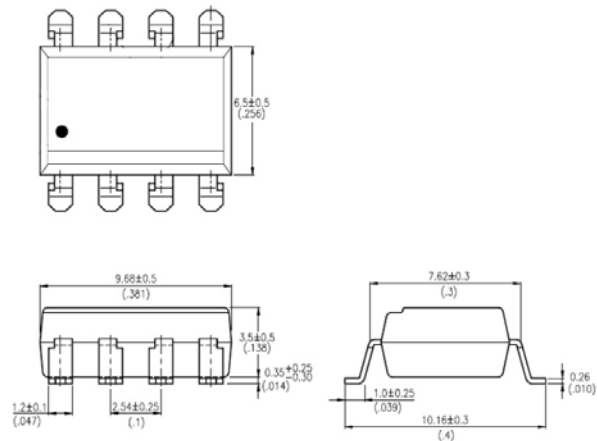
### PACKAGE DIMENSIONS in mm (inch)

#### SMD

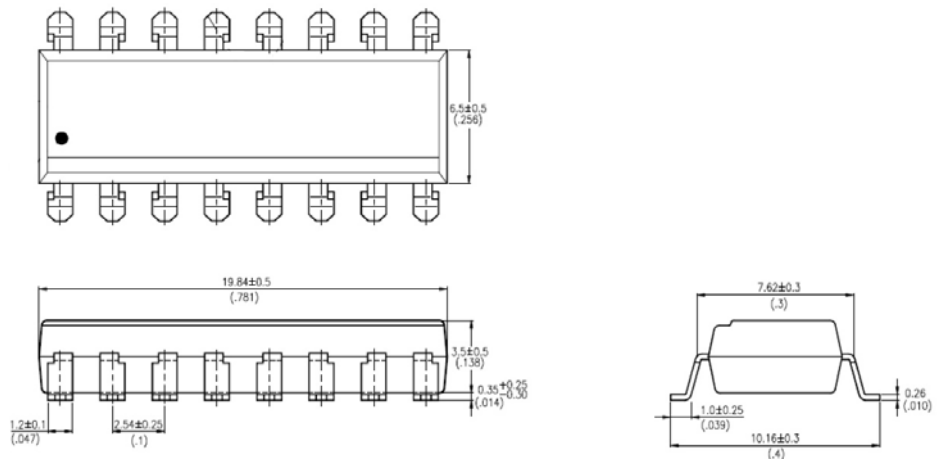
**TLP621SM**



**TLP621-2SM**



**TLP621-4SM**

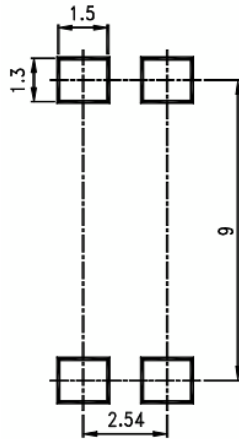




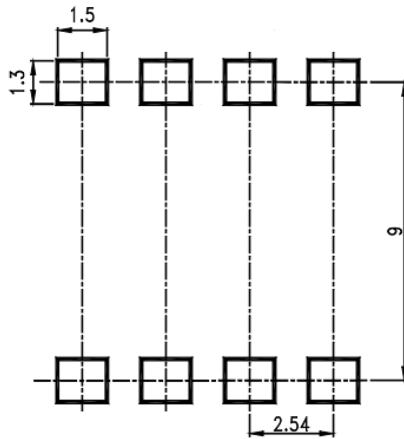
## TLP621, TLP621-2, TLP621-4

### RECOMMENDED PAD LAYOUT FOR SMD (mm)

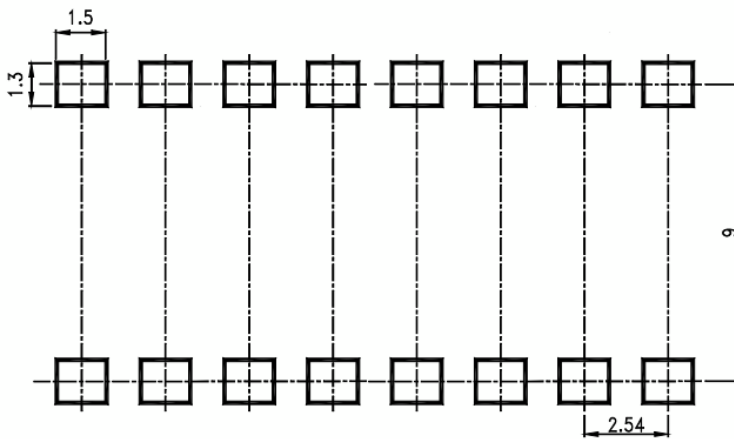
**TLP621SM**



**TLP621-2SM**



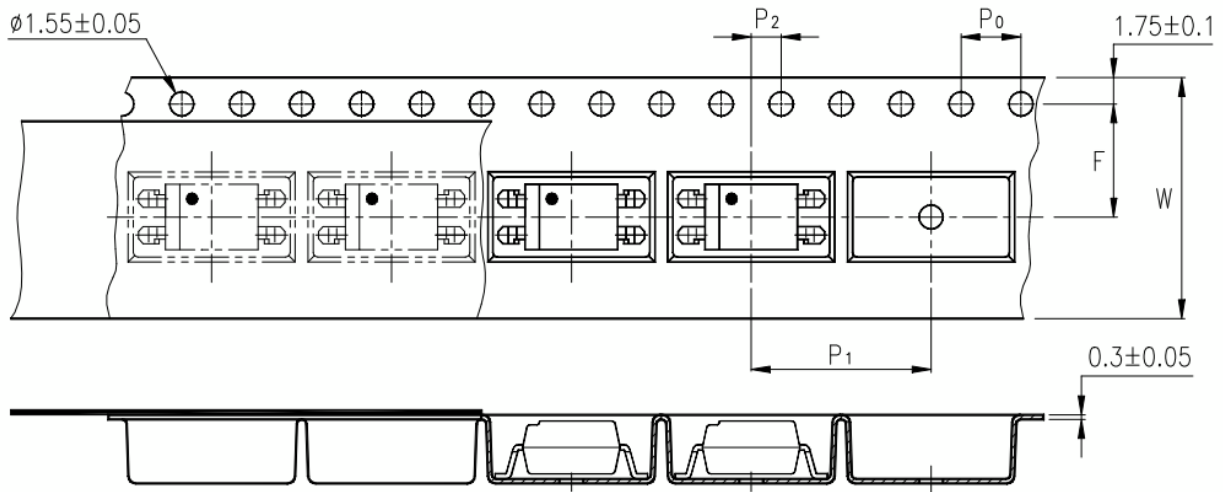
**TLP621-4SM**



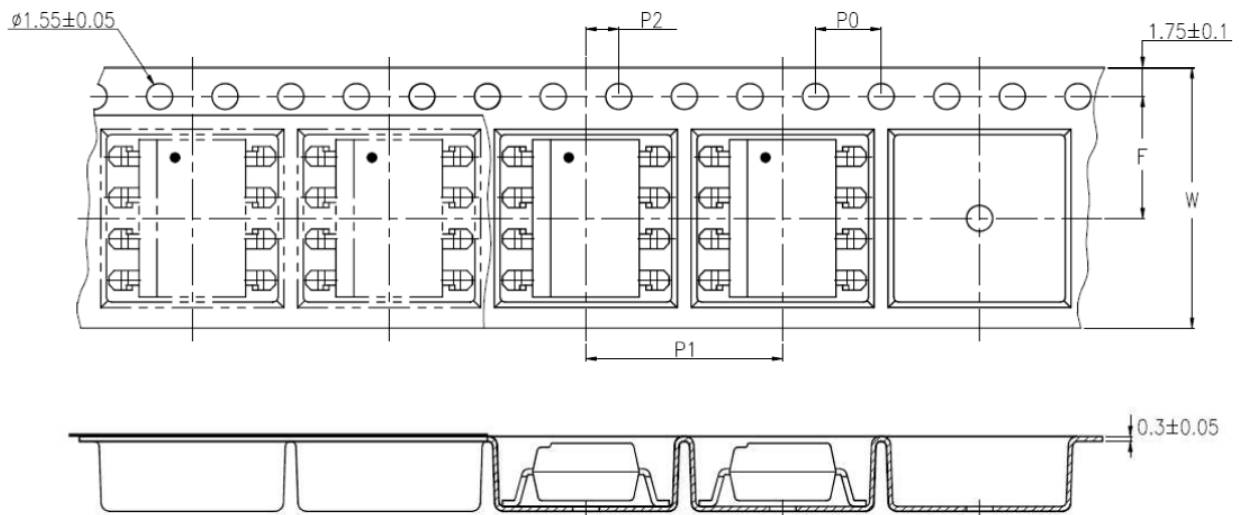


**TLP621, TLP621-2, TLP621-4**

**TAPE AND REEL PACKAGING**



**TLP621SMT&R**



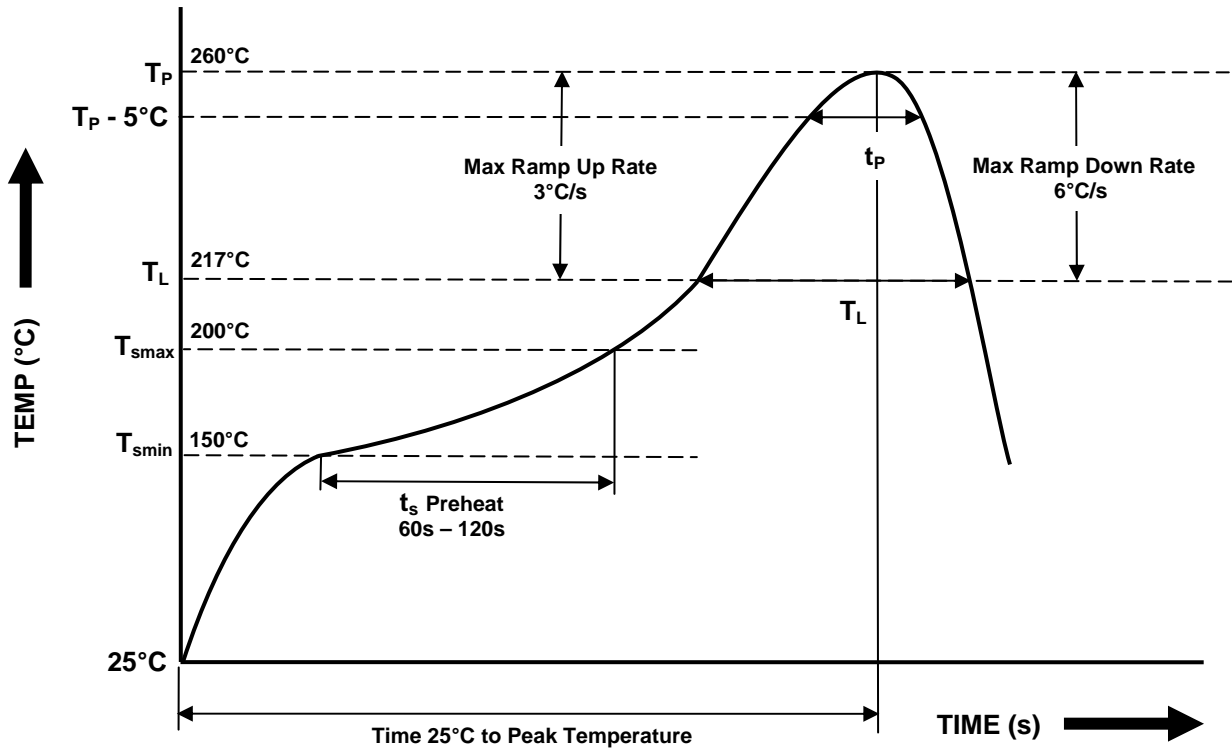
**TLP621-2SMT&R**

| Description                            | Symbol | Dimensions in mm ( inches ) |
|--|--------|-----------------------------|
| Tape wide                              | W      | $16 \pm 0.3$ ( .63 )        |
| Pitch of sprocket holes                | $P_0$  | $4 \pm 0.1$ ( .15 )         |
| Distance of compartment                | F      | $7.5 \pm 0.1$ ( .295 )      |
| Distance of compartment to compartment | $P_2$  | $2 \pm 0.1$ ( .079 )        |
| Distance of compartment to compartment | $P_1$  | $12 \pm 0.1$ ( .472 )       |



**TLP621, TLP621-2, TLP621-4**

**IR REFLOW SOLDERING TEMPERATURE PROFILE FOR SMD  
(One Time Reflow Soldering is Recommended)**



| Profile Details   | Conditions   |
|---|--|
| <b>Preheat</b><br>- Min Temperature ( $T_{SMIN}$ )<br>- Max Temperature ( $T_{SMAX}$ )<br>- Time $T_{SMIN}$ to $T_{SMAX}$ ( $t_s$ )   | 150°C<br>200°C<br>60s - 120s   |
| <b>Soldering Zone</b><br>- Peak Temperature ( $T_P$ )<br>- Time at Peak Temperature<br>- Liquidous Temperature ( $T_L$ )<br>- Time within 5°C of Actual Peak Temperature ( $T_P - 5^\circ C$ )<br>- Time maintained above $T_L$ ( $t_L$ )<br>- Ramp Up Rate ( $T_L$ to $T_P$ )<br>- Ramp Down Rate ( $T_P$ to $T_L$ ) | 260°C<br>10s max<br>217°C<br>30s max<br>60s - 100s<br>3°C/s max<br>6°C/s max |
| Average Ramp Up Rate ( $T_{smax}$ to $T_P$ )  | 3°C/s max  |
| Time 25°C to Peak Temperature   | 8 minutes max  |



**ISOCOM**  
COMPONENTS

## TLP621, TLP621-2, TLP621-4

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- The contents described herein are subject to change without prior notice.
- Do not immerse device body in solder paste.



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